Sensors and Materials

Special Issue on Advanced Sensors Materials and Processes

Call for Papers

There are many applications where sensors, such as strength, distance, height, and pressure sensors, are used daily. Sensors are also heavily used in aerospace, intelligent manufacturing, and IoT. This special issue focuses on the advanced materials and processing technologies of sensors used in everyday life, manufacturing, and IoT applications, including materials, systems, design, and manufacturing techniques. The materials used can be carbon, metals, ceramics, polymers, and related composite materials. We also welcome papers on sensor applications of biomolecular materials, microorganisms, and various organic and inorganic materials.

Scope:

Sensor design
Sensor materials
Sensor applications
Sensor fabrication
Intelligent sensors

Sensors in life
Sensors in manufacturing
Sensors in IoT
Sensors in systems
Sensors in biomedicine

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